	2010	000000	I	DON Dates	_		20 20	110	
PCN Number: 201908200					Αι	Aug. 29, 2019			
Title: Datasheet for TPS1H000-Q1									
<b>Customer Contact:</b>	<u>PCN</u>	<u>Manager</u>				)eį	ot:	Quality Services	
Change Type:						_			
Assembly Site			Design					Bump Site	
Assembly Process			Data Silect			Щ	Wafer Bump Material		
Assembly Materials			Part number change			Щ	Wafer Bump Process		
Mechanical Specification			Test Site			Щ	Wafer Fab Site		
Packing/Shipping/Labeling			Test Process			4	Wafer Fab Materials		
						Wafer Fab Process			
Notification Details									
Description of Change:									
Texas Instruments Incorporated is announcing an information only notification.									
The product datasheet(s) is being updated as summarized below.  The following change history provides further details.									
The following change in	istory	provides it	irther deta	alis.					
II TOYAC									
TEXAS INSTRUMENTS								TPS1H000-Q1	
					SL	/SD	O6C - AUGI	UST 2017-REVISED JUNE 2019	
								_	
Changes from Revision B	(March	2018) to Revis	sion C					Page	
Changed IN is high and DIAG_EN is high to IN is low and DIAG_EN is low in the Standby Mode section									
The datasheet number	will be	e changing.	_						
Device Family			Change From:			Change To:			
TPS1H000-Q1			SLVSD06B			SLVSD06C			
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/product/TPS1H000-Q1									
HILLD://WWW.LI.COIII/DIO	auct/ i	LOTHOOD_C	/ 1						
inttp://www.ti.com/prot	auct/ I	<u> </u>	<u> </u>						
intip://www.ti.com/prod	aucty i	<u> </u>	<u> </u>						
Reason for Change:	auct/ i	F3111000-C	<u>Z</u> ±						
Reason for Change: To accurately reflect de	vice c	haracteristi	cs.	uality or Relia	abil	ity	v (posi	tive / negative):	
Reason for Change: To accurately reflect de Anticipated impact o	vice c	haracteristi Form, Fur	ics.						
Reason for Change: To accurately reflect de	vice c	haracteristi Form, Fur	ics.						
Reason for Change: To accurately reflect de Anticipated impact o No anticipated impact.	vice on <b>Fit,</b> This is	haracteristi <b>Form, Fur</b> s a specifica	ics. nction, Quation chan	ge announcem	ent				
Reason for Change: To accurately reflect de Anticipated impact o No anticipated impact. to the actual device.	vice on <b>Fit,</b> This is	haracteristi <b>Form, Fur</b> s a specifica	ics. nction, Quation chan	ge announcem	ent				
Reason for Change: To accurately reflect de Anticipated impact o No anticipated impact. to the actual device. Changes to product i	vice on <b>Fit,</b> This is	haracteristi <b>Form, Fur</b> s a specifica	ics. nction, Quation chan	ge announcem	ent				

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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